

Guide for IEEE Authors in Greece

Navigating the open access publication process from
submission to acceptance to OA funding



Choosing Where to Submit <https://publication-recommender.ieee.org/home>

- IEEE Publication Recommender helps authors find the most suitable journal and displays journal's OA Status with submission URL

Note: Open Access status clearly displayed in results.

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Electron Devices

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PERIODICALS

- Electron Devices, IEEE Transactions on
- Electron Devices Society, IEEE Journal of the
- Electron Device Letters, IEEE

CONFERENCES

- 2020 IEEE International Electron Devices Meeting (IEDM)
- 2021 IEEE International Electron Devices Meeting (IEDM)
- 2023 International Electron Devices Meeting (IEDM)
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Aims & Scope:
The IEEE Journal of the Electron Devices Society (J-EDS) is an open-access, fully electronic scientific journal publishing papers ranging from fundamental to applied research that are scientifically rigorous and relevant to electron devices. The J-EDS publishes original and significant contributions relating to the theory, modelling, design, performance, and reliability of electron and ion integrated circuit devices and

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The IEEE Open Journal of Antennas and Propagation covers antennas, including analysis, design, development, measurement, standards, and testing; radiation, propagation, and the interaction of electromagnetic waves with discrete and continuous media; and applications and systems pertinent to antennas, propagation, and sensing, such as applied optics, millimeter- and sub-millimeter-wave techniques, antenna signal processing and control, radio astronomy, and propagation and radiation aspects of terrestrial and space-based communication, including wireless, mobile, satellite, and telecommunications at all frequencies.

The IEEE Open Journal of Antennas and Propagation (IEEE OJAP) welcomes contributions covering aspects from theory and design to applied engineering innovations, topical review, and perspective articles. The journal publishes papers on mature topics as well as on emerging fields, including those at the nexus of other engineering and science disciplines that are dependent upon antennas and propagation. IEEE OJAP is committed to supporting open and transparent research exchange and enabling authors to embrace best practices in data and code sharing.

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Submission Process – OA vs. Hybrid

The **corresponding author** completes the submission process,

- **OA Only** journals only publish open access articles. Authors submitting to OA-only journals must confirm their agreement to the OA charges during the first step of the submission process.
- **Hybrid OA journals** allow authors the option to choose whether they would like their article to be OA or not. Authors submitting to hybrid journals will be asked to make their OA choice after acceptance, during the submission of final materials.

Step 1 of Submission to an OA Only Journal

ScholarOne Manuscripts™

IEEE Power and Energy Technology Systems Journal

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Submission process – Step 2

General requirements may vary journal to journal, but there are several key elements that are important to complete at this time to ensure proper Open Access processing later during publication

- Assigning Authors
- Identifying Institution

Adding Authors During Submission

The submitting author enters all co-author information.

If the co-author does not have an account, the submitting author will create one, and add institution data.

[The submitting author's institution data will be used to match the author with their institutional OA account.](#)

Note: Some institutions will not fund publication if their institution is not listed first.

Submission

- Step 1: Type, Title, & Abstract >
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- Step 3: Attributes >
- Step 4: Authors & Institutions >**
- Step 5: Reviewers & Editors >
- Step 6: Details & Comments >
- Step 7: Review & Submit >

Enter your co-authors' information in the boxes below, then click "Add to My Authors." To check if an author already exists in the journal's database, enter the author's e-mail address and click "Find." If the author is found, their information will be automatically filled out for you. When you are finished, click "Save and Continue."

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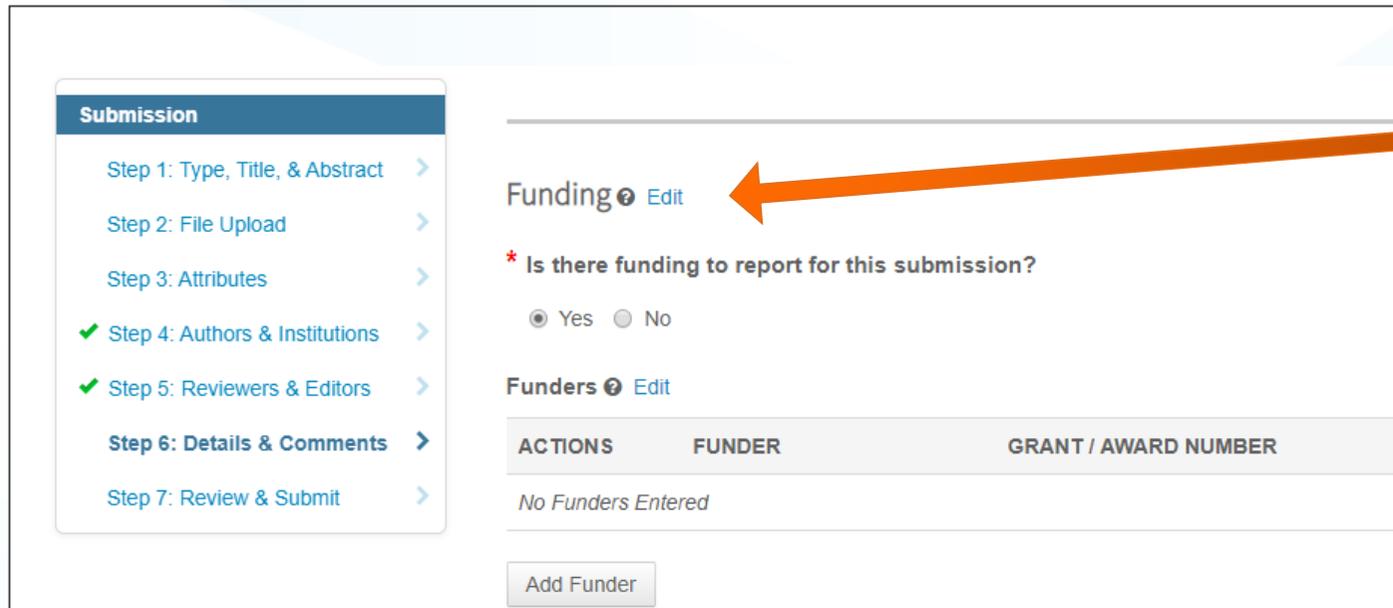
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Entering Funding Information at Submission

The submitting author will be required to disclose any funding information during submission.



The screenshot displays a submission workflow on the left and a 'Funding' form on the right. The 'Funding' section is highlighted with an orange arrow pointing from the text on the right. The form includes a question about reporting funding, radio buttons for 'Yes' and 'No', a 'Funders' table with columns for 'ACTIONS', 'FUNDER', and 'GRANT / AWARD NUMBER', and an 'Add Funder' button.

Submission

- Step 1: Type, Title, & Abstract >
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- Step 3: Attributes >
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Funding [Edit](#)

* Is there funding to report for this submission?

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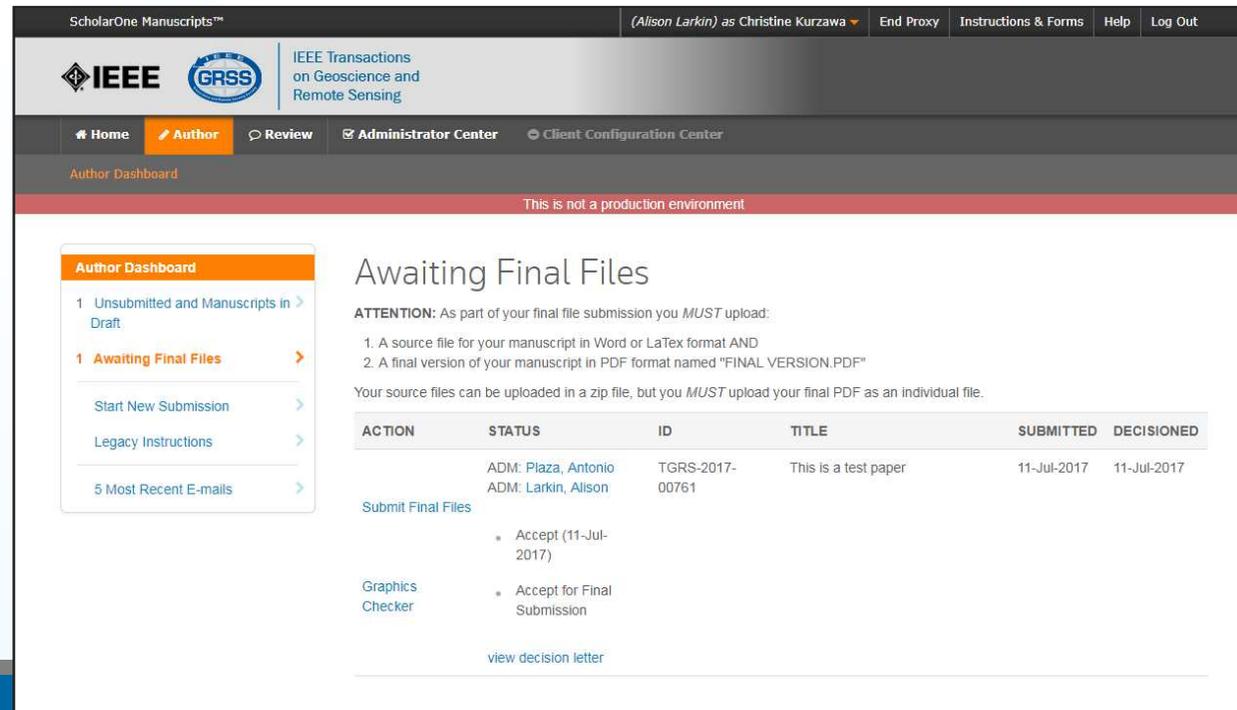
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ACTIONS	FUNDER	GRANT / AWARD NUMBER
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- After acceptance, hybrid journal authors may choose whether to publish open access.



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IEEE GRSS IEEE Transactions on Geoscience and Remote Sensing

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Submit Final Files					
				Accept (11-Jul-2017)	
Graphics Checker				Accept for Final Submission	
				view decision letter	

Post acceptance – hybrid review

Submission

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eCF – step 5

After the author has submitted an electronic signature, they will be able to download a copy of the license agreement.

The screenshot shows the IEEE Publication Agreement interface at Step 5. The title is "IEEE Publication Agreement" with a progress indicator showing steps 1 through 5, where step 5 is highlighted. The main heading is "Step 5: Download your signed publication agreement". Below this, there is a section titled "Thank you for transferring copyright or licensing to IEEE." with two bullet points: "Your IEEE Publication Agreement is now complete." and "A copy will be emailed to you." There is a button labeled "Download the completed Agreement (PDF)". On the right side, there is a "Done" button and an "Information" box that states: "Clicking the 'Done' button will return you to your peer-review system." The IEEE logo is visible in the top right corner of the interface.

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- All article processing charges (APCs) are handled through RLSC.
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